

# Leveraging ASIC AI Chips for Homomorphic Encryption

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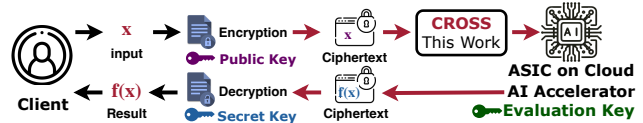
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## Abstract

Cloud-based services are making the outsourcing of sensitive client data increasingly common. Although homomorphic encryption (HE) offers strong privacy guarantee, it requires substantially more resources than computing on plaintext, often leading to unacceptably large latencies in getting the results. HE accelerators have emerged to mitigate this latency issue, but with the high cost of ASICs. In this paper we show that HE primitives can be converted to AI operators and accelerated on existing ASIC AI accelerators, like TPUs, which are already widely deployed in the cloud. Adapting such accelerators for HE requires (1) supporting modular multiplication, (2) high-precision arithmetic in software, and (3) efficient mapping on matrix engines. We introduce the CROSS compiler (1) to adopt Barrett reduction to provide modular reduction support using multiplier and adder, (2) Basis Aligned Transformation (BAT) to convert high-precision multiplication as low-precision matrix-vector multiplication, (3) Matrix Aligned Transformation (MAT) to convert vectorized modular operation with reduction into matrix multiplication that can be efficiently processed on 2D spatial matrix engine. Our evaluation of CROSS on a Google TPUv4 demonstrates significant performance improvements, with up to 161× and 5× speedup compared to the previous work on many-core CPUs and V100. The kernel-level codes are open-sourced at <https://github.com/google/jaxite.git>.

## 1 Introduction

Artificial intelligence (AI) is rapidly evolving and often exceeds human capabilities in diverse applications. Examples



**Figure 1.** HE enables direct computation on encrypted data to enable privacy-preserving model serving.

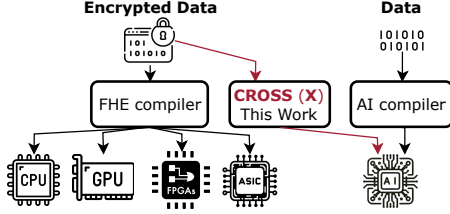
include large language models that excel in complex reasoning and diffusion models that generate creative contents [8, 44, 47, 64]. In order to utilize sensitive or private data for AI, we need strong confidentiality protection for the AI serving life-cycle even in untrusted environments. Homomorphic Encryption (HE) promises strong end-to-end confidentiality by enabling data processing in an encrypted form, as shown in Fig. 1. However, HE inflates data sizes by 200× and computation by 10,000×, resulting in a 1000× slowdown on a multi-core CPU [11, 48, 54, 55].

While HE’s inherent parallelism seems tailor-made for dedicated ASICs [2, 39, 40, 42, 50, 55, 56, 58, 62, 63], the cost of designing, verifying, and maintaining such an ASIC is daunting, often requiring years and millions of dollars. HE implementations on CPUs, GPUs, and FPGAs have made significant strides recently but still fall short of ASICs’ performance by at least 20× [3, 4, 11, 13, 21, 24, 37, 51–53, 57, 60, 66].

To reduce this performance gap without fabricating a custom ASIC only for HE, this paper studies opportunities and challenges in accelerating HE using existing ASICs for Artificial Intelligence (AI), which are already pervasive in the cloud [25, 26, 32]. We propose a compilation framework, **CROSS**<sup>1</sup>, to enable HE deployment on AI accelerators.

\*This work was done before the author joined NVIDIA.

<sup>1</sup>Compiling Real-time Online Secure Service on ASIC AI Accelerators



**Figure 2.** CROSS enables real-time HE serving on existing AI accelerators without hardware modifications.

The following characteristics of AI accelerators make accelerating HE feasible: (1) mix of vector processing unit and matrix multiplication unit that combine to provide a high throughput via a massive number of arithmetic units ( $\geq 10^5$  MACs), (2) large amounts of programmable on-chip memory ( $\geq 100$  MB), and (3) on-chip transpose/shuffling unit to enable parallel irregular memory access.

However, *functionally*, an AI accelerator lacks two features that enable ASIC HE accelerators use to run HE workloads: (1) support for modular arithmetic and (2) high-precision arithmetic (most AI inference accelerators only support 8-bit integer operations). To bridge these gaps, we implement Barrett reduction [12] to facilitate modular operations using existing multiplication, addition, and shift capabilities of AI accelerators. To further enable high precision, we propose chunk decomposition to decompose high-precision data into many low-precision chunks and convert the original high-precision operation into low-precision chunkwise multiplication and reduction.

Despite enabling functional correctness of HE processing in AI accelerators, several challenges hinder *optimal performance*: (1) decomposing a high-precision modular operation into many low-precision chunkwise operations introduces extra on-chip data movement, reducing performance for memory-bounded HE operations, (2) the rigid-shape 2D systolic array in AI accelerators only favors large-scale matrix multiplications, resulting in low computation resource utilization when processing vectorized HE operations including Number Theoretic Transform (NTT) and BasisChange.

To further gain performance, we propose two mapping optimizations in our compiler, CROSS. (1) *Basis Aligned Transformation (BAT)* schedules chunkwise multiplications as dense matrix multiplications. By aligning the additional on-chip data movements with the native datapath of AI accelerators, BAT maximizes data reuse and computational efficiency. (2) *Matrix Aligned Transformation (MAT)* reformats both the computation and data layouts of vectorized operations from NTT and basis change into matrix forms. These matrix representations are then transformed into larger low-precision matrix multiplications through BAT. Leveraging the synergy between BAT and MAT, CROSS enhances overall compute utilization of both vector processing units and matrix multiplication units in AI accelerators while reducing memory accesses and on-chip memory storage requirements.

To the best of our knowledge, CROSS represents the first work to investigate deployment of HE workloads on AI accelerators, introducing a new paradigm of AI/HE co-acceleration on the same hardware substrate (see Fig. 2).

CROSS shows that AI accelerators without any additional hardware support can indeed be used to accelerate HE workloads that require no bootstrapping.

Our evaluation of HE implementation on Google TPUv4 shows that we can achieve as much as a 12 $\times$  speedup over Lattigo [48] on a CPU, 5 $\times$  speedup over a previous GPU implementation (100 $\times$  [35]) on an NVIDIA V100, and 1.05 $\times$  speedup over an FPGA implementation (Xilinx U280 [3]). While still approximately 50 $\times$  slower than a well-designed HE ASIC, the lack of commercial HE chips and the widespread availability of TPU-like AI accelerators make our approach highly compelling. The primary performance gap with HE ASICs stems from the absence of dedicated modular reduction units in TPUs. Adding such units can bring an additional 1.34 $\times$  speedup, as discussed in §6.4.

This result suggests that HE acceleration on ASIC AI accelerators is a promising direction to investigate. ASIC AI accelerators can provide significantly higher HE performance compared to CPUs and be competitive to other programmable accelerators such as GPUs and FPGAs. We note that the current experimental results do not include bootstrapping, which may be required for large applications, and the HE performance on GPUs and FPGAs can also be improved with optimizations. For example, a more recent study (Cheddar [38]) on GPU-based HE acceleration reports higher HE performance on an NVIDIA A100. In that sense, fully understanding the potential of AI accelerators for complex HE applications with bootstrapping and the detailed comparisons across different programmable accelerators will need further studies.

We make the following contributions in this paper:

- A systematic characterization of HE operators consisting of (1) computation analysis and latency profiling of various HE operators, identifying NTT/INTT, Basis Change, and element-wise multiplication as the key performance bottlenecks. These operators account for 74.5%  $\sim$  92.3% of the overall latency under Brakerski/Fan-Vercauteren (BFV) and Cheon, Kim, Kim and Song (CKKS); (2) a programmer’s view of available functionalities inside ASIC AI accelerators. (3) the gap between workloads and hardware.

- A novel compilation framework, CROSS, to systematically lower HE kernels into hardware primitives on off-the-shelf AI accelerators without any hardware modifications. At its core, CROSS introduces *BAT*, a foundational set of arithmetic transformations that map high-precision scalar modular operations to low-precision hardware. Using BAT, CROSS achieves highly efficient vectorized modular operations (VecModOp) and modular matrix multiplication (ModMatMul), which are critical for most HE kernels. For complex HE kernels like NTT, CROSS further proposes *MAT* to reformulate

interleaved VecModOps with cross-coefficient reduction as ModMatMul, ensuring efficient execution.

- We conducted a comprehensive evaluation of the HE operators on TPUv4 across various practical security parameters. Our TPUv4 implementation achieved up to a  $12\times$  speedup over a SotA CPU implementation (Lattigo [48]) on an Intel i5-6600k, a  $5\times$  speedup over a GPU implementation on an NVIDIA V100 ( $100\times$  [35]), a 50% slowdown over a GPU implementation on an NVIDIA A100 (Cheddar [38]), and a  $1.05\times$  speedup over a SotA FPGA implementation (FAB [3]) on Xilinx Alevo U280. We note that A100s use a new technology node and have higher power consumption compared to TPUv4. These results demonstrate that AI accelerators like TPUv4 can perform HE operations competitively with SotA GPU and FPGA implementations, indicating a promising direction for further exploration, including computationally intensive tasks like bootstrapping.

## 2 Background and Motivation

In this section, we introduce the background for Homomorphic Encryption (HE) and discuss key potential of AI accelerators for HE acceleration.

### 2.1 Homomorphic Encryption Background

HE is a specialized form of public-key encryption that enables computations to be performed directly on encrypted data without revealing the underlying plaintext. In an HE system, the client exclusively holds a private decryption key, while a public encryption key is made available for data encryption. Additionally, an evaluation key is provided to the cloud or computing service to facilitate computations on the encrypted data. In HE, direct computation on the encrypted data will apply computation on the underlying messages, such that the entire computation is secured in the privacy-preserving manner as shown in Fig. 1.

**2.1.1 Terminology and Data Representation.** The security of HE schemes is based on the hardness of Ring Learning With Errors (RLWE) problem [46]. This is a problem over a polynomial ring  $R_Q := \mathbb{Z}_Q[x]/(x^N+1)$ , where  $N$  is a power of two. An element in  $R_Q$  is a polynomial of the form  $a(x) = \sum_{j=0}^{N-1} a_j \cdot x^j$ , where each coefficient  $a_j$  is an integer in  $[0, Q-1]$  and the polynomial is reduced by  $x^N+1$ .

**2.1.2 Residue Number System (RNS).** To achieve 128-bit security level, ciphertexts coefficients need high-precision, i.e. up to thousands of bits [5, 58], which are not natively supported by the 32-bit computational architectures in CPUs or GPUs. Naively, mapping high-precision data to low-precision computation unit requires two steps: (1) breaking high-precision coefficients into low-precision chunks supported by computation units and (2) executing multiplicative operations

across all pairs of chunks from two coefficients. This segmentation and *chunkwise multiplication* incur *quadratic* computational overheads.

To reduce such quadratic pair-wise computation costs, the Chinese Remainder Theorem (CRT) allows us to construct a set of coprime RNS basis  $\{q_0, \dots, q_{L-1}\}$ , where  $Q = \prod_{i=0}^{L-1} q_i$ . Under CRT, each high-precision coefficient  $a_j, j \in [0, N-1]$  of a polynomial in  $R_Q$  is represented as residues of a sequence of  $L$  smaller moduli  $\{a_j \bmod q_i\}$  for  $i \in [0, L-1]$ . These  $L$  obtained polynomials with low-precision coefficients are referred to as limbs, noted as  $(limb_i), i \in [0, L-1]$ . The isomorphism  $R_Q \cong R_{q_0} \otimes \dots \otimes R_{q_{L-1}}$  allows addition and multiplication to be performed "limb-wise" over elements of  $R_Q$ . Thus, a limb of one polynomial multiplies only with its counterpart limb of another polynomial, reducing quadratic computational overhead down to linear. In the post-CRT ciphertext, different limbs get processed independently, facilitating limb-level parallelism. A summary of the notations is listed in Tab. 1.

However, RNS cannot directly reduce high-precision data to an arbitrary low precision due to inherent constraints. Specifically, RNS requires a set of moduli that (1) multiply to the original modulus  $Q$ , and (2) are pairwise co-prime. On typical AI accelerators [32, 34], the lowest supported precision is 8-bit integer arithmetic. To reduce 2000-bit data to 8 bits,  $2000/8 = 250$  primes are needed. However, it is infeasible to find 250 co-prime integers within the 8-bit range  $[0, 256)$ . Consequently, precision reduction to 8-bit arithmetic involves two stages:

- (1) *Linear Precision Reduction*: RNS lowers high precision to an intermediate precision (e.g., 32-bit) with linear complexity.
- (2) *Quadratic Precision Reduction*: A secondary reduction further lowers the intermediate precision to 8-bit arithmetic, incurring quadratic complexity.

**Table 1.** Notations

Term	Conditions	Meaning (example value)
$N$	Power of two	Polynomial Degree ( $2^{16}$ )
$Q$		Ciphertext modulus (1728 bits)
$q_i$	coprime	RNS base $Q = \prod_{i=0}^{L-1} q_i$ (32 bits)
$L$	$\log(Q)/\log(q_i)$	The number of limbs ( $\lceil 1728/32 \rceil$ limbs)
$\log(q)$		RNS bases have $\log(q)$ bits
$bp$		bit precision of MAC in hardware
$\omega$		a primitive $2N$ -th root of unity
$a_k \sim e_k$	$k \in [0, N-1]$	$k$ -th degree coefficient of polynomial
$\mathbf{a} \sim \mathbf{e}$		coefficient vector
$dnum$		Number of digits in the switching key
$\mathbf{m}$		Original input message
$\llbracket \mathbf{m} \rrbracket$	$\llbracket \mathbf{m} \rrbracket = (P_{m1}, P_{m2})$	Ciphertext encrypting message $\mathbf{m}$
$[\mathbf{P}_m]_{q_i}$		$q_i$ limb of $\mathbf{P}_m$
$P$	$P = \prod_{j=1}^{L'} p_j$	Auxiliary modulus
$K$		number of chunks
$L'$		number of limbs with auxiliary modulus
$C$	$C = q_0, \dots, q_{L-1}$	A set of RNS bases. Also noted as $\mathcal{B}$ .
$(\mathbf{a})_C$		coefficients vector under bases $C$

**2.1.3 Parameter Determination.** The security level is determined by a pair of (degree  $N$ , ciphertext modulus bitwidth

$\log_2(Q)$ ) for a given error standard deviation. Practical applications typically require 128-bit security level, which comes in various choices from  $(2^{10}, 29)$  [5] to  $(2^{17}, 2200+)$  [58]. A larger coefficient modulus ( $\log_2(Q)$ ) allows more computation on a ciphertext before bootstrapping is required, but the degree  $N$  of the polynomial modulus must grow with  $\log_2(Q)$  in order to maintain security. Larger  $Q$  and higher degree both lead to longer compute latency. Therefore, the minimal (degree,  $\log_2(Q)$ ) that satisfies the required computation is often selected to minimize overheads.

## 2.2 HE Hardware Acceleration Requirements

In order to understand how prior works accelerate HE workloads and the performance limit of each candidate hardware, in this section, we first categorize the key challenges introduced by the HE workloads, followed by several speedup ingredients widely used by prior HE accelerators.

**2.2.1 Challenges of HE Workloads.** The overheads of HE are two-fold. First, HE encoding and encryption introduce about  $200\times$  data expansion of the original message, making HE operators memory-bound for devices with small on-chip memory (*memory overhead*) [22, 35]. Second, evaluating encrypted data also introduces extra computation complexity, i.e. raw multiplication becomes ring polynomial multiplication in HE (*computation overhead*). Therefore, improving overall latency and efficiency boils down to reducing both off-chip data accesses and computation latency.

**2.2.2 Key Hardware Speedup Ingredients.** For both goals above, four key performance ingredients have been widely proposed in various compute platforms (Tab. 2).

- **High Clock Frequency:** It trades more power for low latency of computation and data movement.
- **High Parallelism:** HE workloads exhibit inherent parallelism due to the independence across ciphertexts, limbs and polynomial degree etc. Such independence brings high parallelism. For instance, under a 128-bit security parameter, a single raw-value multiplication necessitates at least  $N = 2^{16}$  vectorized modular coefficient multiplications, all of which can be executed in parallel.
- **Large On-chip Memory:** HE workloads are often memory-bound [22, 35]. A sufficient on-chip memory caches commonly accessed data to reduce repeated data accesses from off-chip memory, saving critical latency.
- **Specialized Units:** HE operations are not natively supported in general-purpose hardware, leading to low performance mappings. For example, performing high-precision modular operations in HE using low-precision multipliers and adders on CPU or GPU are slow. A specialized modular reduction unit for selected category of modulus could deliver up to two order of magnitude speedup. Further, HE operations such as NTT demonstrate static but different memory access patterns. The solutions are

two-fold in prior works [3, 39, 40, 43, 54, 55]: (1) hardcode a dedicated hardware unit for each pattern, delivering significant performance improvement at cost of area and scheduling, (2) design an extra on-chip permutation unit that could support all required memory access patterns, e.g., transpose unit. Both deliver better performance and efficiency by non-consecutive access patterns into contiguous ones.

**2.2.3 HE ASIC Accelerators.** Examining CraterLake [55] as a representative HE ASIC accelerator, it showcases several features that enhance HE processing efficiency:

- **Freq.:** CraterLake operates at a 1 GHz clock frequency, which is  $3.33\times$  higher than that of typical FPGA accelerators with dedicated architecture for HE operations.
- **High Parallelism:** It includes dedicated hardware components for HE operators, to offer an overall throughput of 165888 parallel 28-bit ModMuls.
- **Large Memory:** With 256 MB on-chip memory, CraterLake can store up to 21 ciphertexts, facilitating high parallelism with minimal reliance on off-chip memory access.
- **Specialized Units:** It features a specialized network designed to perform fixed-size matrix transpositions, hiding explicit memory latency behind critical path.

Despite significant performance gains, the design and fabrication of specialized hardware require years of development and millions of dollars in capital expenditure. Moreover, the development of practical software toolchains to support such dedicated hardware further delays market readiness. These substantial investments in time and resources explain why no commercially available products exist as of now.

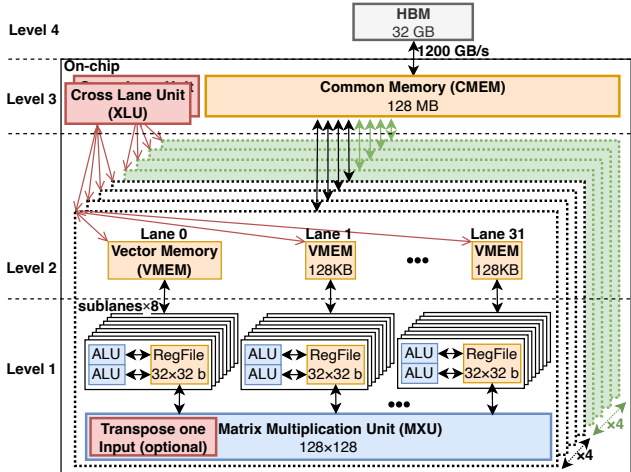
## 2.3 Potential of AI Accelerators for HE Workloads

This work demonstrates that AI accelerators (e.g. TPUv4) equipped with compilation support could bring an extra order of magnitude higher performance per watt to GPU/FPGA implementations based on following insights.

- **Large Compute Array (Parallelism):** Each MXU in AI accelerators is  $32\times$  larger (e.g.,  $128\times 128$  in TPUv4) than those in GPUs (typically  $4\times 4$ ). The larger size of MXUs increases on-chip data reuse within the two-dimensional computation arrays, enhancing throughput per watt. Moreover, a sea of 2048 SIMD ALUs, sharing the same regfiles with MXUs, further increase data reuse.
- **Large On-chip Memory:** AI accelerators feature large on-chip memory. For instance, a single Google TPU v4 chip has 160 MB of on-chip memory, including 128 MB CMEM and 32 MB VMEM array in Fig. 3, which is  $20\times/4\times$  larger than the AMD MI100 / NVIDIA A100. This substantial on-chip capacity can accommodate entire ciphertexts, eliminating the need for repeated accesses to off-chip memory. By reducing off-chip memory traffic, it conserves bandwidth for fetching other necessary data and

**Table 2.** Acceleration techniques from various hardware, with key attributes that make AI accel. potential for HE in bold.

	Intel Xeon 9282 CPU [31]	AMD 5950X CPU [7]	AMD MI100 GPU [6]	NVIDIA A100 GPU [49]	FAB [3] FPGA	CraterLake [55] HE ASIC	<b>Google TPUv4 [32]</b> AI ASIC	MTIA [25] AI ASIC
Technology Node	Intel 14nm	TSMC 7nm	TSMC 7nm	TSMC 7nm	TSMC 7nm	14/12 nm	TSMC 7nm	TSMC 7nm
<b>Clock Frequency (GHz)</b>	2.6~3.8	2.9~5.1	1.502	1.095	0.3	1	1.05	0.8
Throughput (INT8 TFlops)	N/A	N/A	184.6	624	24.5 [10]	N/A	275	102.4
Power (W)	400	105	300	400	225	400	170	25
<b>Throughput Per Watt</b>	N/A	N/A	0.615	1.56	0.11	N/A	<b>1.61</b>	4.096
<b>On-chip Memory (MB)</b>	77	64	8	40	43	256	<b>128+32</b>	128
<b>Specialized Unit</b>	AVX512	AVX512	SMT	SMT	Modular; Flexible datapath	Modular; NTT; Transpose	<b>Transpose</b>	Transpose

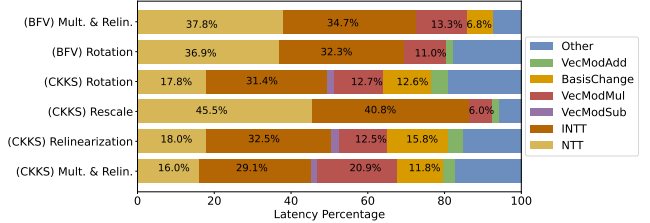


**Figure 3.** Overview of TPUv4 architecture based on public information [28, 32–34]. Four black dot boxes and four green dot boxes represent two tensor cores, separately. Two tensor cores share the same 128 MB common memory (CMEM). Each tensor core has 4 matrix multiplication units (MXU) and 2048 ALUs in Vector Processing Unit (VPU) organized as 128 SIMD lanes. Each lane consists of 8 SIMD sublanses with 128 KB vector memory (VMEM), each sublanses has 2 dual-issue ALUs and 128 B local register file. Each MXU features a  $128 \times 128$  systolic array, and takes inputs from VMEMs. Each MXU is capable of performing matrix multiplication and each MXU has a local transpose unit to optionally transpose one input matrix in the pipelined manner to hide reordering latency behind. Data in VMEM of different lanes could get transposed or shuffled or reduced through the Cross Lane Unit (XLU), which consumes non-hidden layout reordering and reduction latency. The CMEM holds frequently used data to reduce off-chip memory accesses.

alleviates the memory bottlenecks inherent in HE workloads, leading to improved performance and efficiency.

- **Specialized Units:** AI ASICs consist of specialized on-chip transpose and permutation unit such as red Cross Lane Unit (XLU) in Fig. 3, which could be used to (1) permute or transpose data layout to convert strided on-chip memory access patterns into consecutive access patterns for less on-chip memory access latency, and (2) reduce data among multiple compute lanes.

In summary, *large compute array, large on-chip memory and flexible permutation/transpose/reduction engine* in Tab. 2 enable AI accelerators to achieve better *performance per watt*



**Figure 4.** Latency profiling of HE Operators using OpenFHE, picking representative values for the parameters in Tab. 1. Vectorized Modular Multiplication (VecModMul), Addition (VecModAdd) and Subtraction (VecModSub) only count for latency not belonging to (I)NTT/Basis Change.

in HE acceleration over existing CPU, GPU and FPGAs. However, effectively leveraging these abundant resources to accelerate HE remains a challenge due to the misalignment between computational patterns of HE workloads and architectural capabilities of AI accelerators.

The key of CROSS compiler framework is to convert high-precision modular HE workloads into low-precision convolution and matrix multiplication (GEMM) that could be efficiently processed on AI accelerators without any hardware modifications to achieve SotA performance per watt.

With this aim, we first characterize such misalignment and summarize key functional and performance challenges in §3. The key two ingredients of CROSS to bridge functional and performance misalignments, *Basis Align Transformation (BAT)* and *Matrix Align Transformation (MAT)* are then introduced in §4. Detailed analysis of using BAT and MAT for efficiently accelerating HE bottleneck operators, including NTT and BasisChange are introduced in §5, followed by an extensive evaluation, comparison to SotAs and conclusion.

### 3 Obstacles to Using AI Accelerator for HE

This section analyzes bottlenecks of HE operators and categorizes challenges of deploying them to AI accelerators.

#### 3.1 Compute Patterns of Bottleneck HE Kernels

HE workloads fundamentally boil down to the scheduled invocation of essential HE operators, including HE Multiplication (Mult.), Relinearization (Relin.), Rotation, and Rescaling. In other words, the performance of these operators directly determines the overall serving latency of HE workloads. To identify performance bottlenecks, we profiled various HE operators on an AMD Ryzen 9 5950X CPU with AVX support using OpenFHE library. The latency breakdown, presented

in Fig. 4, reveals NTT, and its inverse (INTT), Basis Change, and Vectorized Modular Multiplication (VecModMul) and Addition (VecModAdd) are the five most time-consuming HE kernels in both CKKS and BFV schemes.

**3.1.1 Number Theoretic Transform (NTT).** The NTT converts polynomial representations from the coefficient domain to the evaluation domain, where polynomial multiplication simplifies to element-wise (vectorized) coefficient multiplication. The NTT and INTT are computationally intensive, accounting for approximately 45.1% to 86.3% of the overall latency in various HE operators.

The detailed algorithm is provided in Algorithm 1. In general, an  $N$ -point NTT consists of  $\log_2(N)$  stages. Compute-wise, each stage comprises  $\frac{N}{2}$  vectorized modular multiplications, additions, and subtractions, denoted as  $\frac{N}{2}$ -VecModMul,  $\frac{N}{2}$ -VecModAdd, and  $\frac{N}{2}$ -VecModSub, respectively; Memory-wise, each stage also requires bit-complement shuffling [20].

Considering 8-point NTT depicted in Fig. 5a as an example, in stage 1, we perform a 4-element vectorized modular multiplication between  $[a_4, a_5, a_6, a_7]$  and  $[\omega, \omega^2, \omega^3, \omega^4]$ :

$$[\tilde{a}_4, \tilde{a}_5, \tilde{a}_6, \tilde{a}_7] = [a_4 \cdot \omega, a_5 \cdot \omega^2, a_6 \cdot \omega^3, a_7 \cdot \omega^4] \pmod{q}$$

Then  $vec = [a_0, a_1, a_2, a_3, \tilde{a}_4, \tilde{a}_5, \tilde{a}_6, \tilde{a}_7]$  is being reduced with the bit complement shuffled result of itself  $vec = vec \pm \text{bit\_complement\_shuffle}(vec)$  using vectorized modular addition and subtraction to produce:

$$[b_0, b_1, b_2, b_3] = [a_0 + \tilde{a}_4, a_1 + \tilde{a}_5, a_2 + \tilde{a}_6, a_3 + \tilde{a}_7] \pmod{q}$$

$$[b_4, b_5, b_6, b_7] = [a_0 - \tilde{a}_4, a_1 - \tilde{a}_5, a_2 - \tilde{a}_6, a_3 - \tilde{a}_7] \pmod{q}$$

The bit-complement shuffling in the first stage has a group size of 8 elements [20], as illustrated by the permutation arrows in Fig. 5a. Subsequent stages perform the same bit-complement permutation with the group sizes decreasing by powers of 2 per stage.

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#### Algorithm 1 Cooley-Tukey NTT [1]

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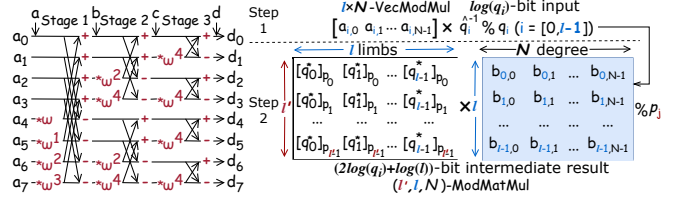
**Require:** Coefficients set of input polynomial  $P_m = (a_0, a_1, \dots, a_{N-1})$ ,  $N$ -th root of unity  $\omega$ , total degree  $N$ .

**Ensure:**  $NTT(P_m) = (b_0, b_1, \dots, b_{N-1})$

- 1: Initializes  $b_i = a_i, i \in [0, N-1]$ ;  $\omega' = \omega$
  - 2: **for**( $n = N, n > 1, n = n \gg 1$ ) ▷ Stage index
  - 3:  $\omega_n = \omega^{\frac{N}{n}} \pmod{q}$
  - 4: **for**( $i = 0, i < n, i = i + n$ )
  - 5: **for**( $j = 0, j < n, j = j + n/2$ )
  - 6:  $b[k+j] = (b[k+j] + \omega' b[k+j+n/2]) \pmod{q}$
  - 7:  $b[k+j+n/2] = (b[k+j] - \omega' b[k+j+n/2]) \pmod{q}$
  - 8:  $\omega' = \omega \cdot \omega_n \pmod{q}$
- 

**3.1.2 Basis Change.** Basis change is used to scale up or down polynomials in HE multiplication and rotation. An example of basis conversion from  $\mathcal{C}$  into  $\mathcal{B}$  is [16]:

$$\text{Conv}_{\mathcal{C} \rightarrow \mathcal{B}}((\mathbf{a})_{\mathcal{C}}) = (\sum_{i=0}^{l-1} [a_{n,i} \cdot \hat{q}_i^{-1}]_{q_i} \cdot [q_i^*]_{p_j} \pmod{p_j})_{0 \leq j < l', 0 \leq n < N}$$



(a) 8-input NTT

(b) Basis Change

**Figure 5.** Illustration of computation patterns of NTT and Basis Change, superscript represents exponent.

where  $\hat{q}_i^{-1}$  and  $[q_i^*]_{p_j}$  could be generated offline and get loaded into the on-chip memory as static parameters during runtime. During ModUp operation,  $l = L/dnum$ ;  $l' = K + (L - L/dnum)$ , while in ModDown  $l = K, l' = L$  (Tab. 1)

The above equation is broken into two steps (Fig. 5b).

- Step 1:  $b_{n,i} = [a_{n,i} \cdot \hat{q}_i^{-1}]_{q_i}, 0 \leq i < l, 0 \leq n < N$  invokes  $l$  independent instances of  $N$ -length Vectorized Modular Multiplication, noted as  $l \times N$ -VecModMul for simplicity.
- Step 2:  $c_{n,j} = \sum_{i=0}^{l-1} b_{n,i} \cdot [q_i^*]_{p_j} \pmod{p_j}, 0 \leq j < l', 0 \leq n < N$ . It invokes one  $M_{N \times l'} = M_{N \times l} \cdot M_{l \times l'}$  Modular Matrix Multiplication, noted as  $(N, l, l')$ -MatModMul.

## 3.2 Challenges of Accelerating HE on TPUv4

**Table 3.** HE computational patterns vs. AI accel. capabilities

	Primitive	Precision	Operation
HE	VecModAdd	$\log q$	$(\mathbf{a} + \mathbf{b}) \pmod{q}$
	VecModMul	$\log q$ ①	$(\mathbf{a} \times \mathbf{b}) \pmod{q}$
	ModMatMul	$\log q$ ②	$M_{H \times V} \cdot M_{V \times W} \pmod{q}$
	bit-complement shuffle	$\log q$	③ [20]
AI Accel.	VecAdd	(u)int32	$\mathbf{a} + \mathbf{b}$
	VecMul	(u)int32	$\mathbf{a} \times \mathbf{b}$
	MatMul	(u)int8	$M_{H \times V} \cdot M_{V \times W}$
TPUv4	Transpose	32 bit	$M_{H \times V} \rightarrow M_{V \times H}$
	Permutation	32 bit	Across Lane (Fig. 3)

①:  $28 \leq \log q \leq 59$  under 128-bit security level; Intermediate results need  $2 \log q$  bits, far exceeding precision range of typical AI accelerators.

②: intermediate results need  $2 \log q + \log V$  bits to avoid overflow.

③: Bit complement negates the MSB of the binary representation of the index. Let  $s_i, d_i$  denote  $i$ -th bit of binary representation of a source and destination index of a value. Eg. after bit complement shuffling 8 elements, the 7-th value will go to the third location:

$$7 = \{s_2 = 1, s_1 = 1, s_0 = 1\} \rightarrow \{d_2 = \neg s_2, d_1 = s_1, d_0 = s_0\} = 3.$$

A comparison between the computational patterns of HE workloads and the capabilities of AI accelerators like TPUv4, as detailed in Table 3, reveals following *functional barriers*:

- **Lack of Native Modular Operations:** Neither the MXU nor VPU natively support modular reduction operations, which are fundamental to HE workloads.
- **Low-Precision Multipliers:** The MXU utilizes int8/bfloat16 multipliers with int32 adders, while the VPU operates with FP32/int32 arithmetic. These low-precision units are insufficient for HE workloads with 28~59-bit post-RNS precision requirements.

Moreover, leveraging key architectural features of AI accelerator for HE presents additional *performance challenges*:

- **Memory Organization Constraints:** HE workloads are memory-bound, and misalignment between the bit-complement shuffling patterns required by NTTs and the transpose or permutation supported by AI accelerators increases the memory bandwidth requirements, exacerbating inefficiencies of memory boundness.
- **Parallelism Misalignment:** The parallelism in TPUv4 stems from its systolic array-based MXU, which is highly efficient for low-precision, large-scale dense matrix multiplication. However, most HE kernels, especially NTT, are inherently vectorized operations rather than matrix multiplications, leading to suboptimal MXU utilization.

Effectively addressing functional and performance gaps is crucial for enabling AI accel. to efficiently accelerate HE.

## 4 CROSS Compilation Framework

This section introduces how CROSS supports (1) scalar modular operation, (2) vectorized modular operations, and (3) modular matrix multiplication.

### 4.1 Enable Efficient High-precision Scalar Mod. Ops

HE has high-precision modular scalar multiplication, introducing two challenges for low-precision AI accelerators: (1) lack of modular reduction and (2) precision gap. This subsection introduces solutions separately.

#### 4.1.1 Enable Modular Reduction as Multiplication.

CROSS adopts the Barrett modular reduction [12] to convert modular multiplication into two multiplications, one shifted multiplication, up-to two subtractions as signified in Alg. 2 with precision listed in comments. But these operations still deal with high-precision data.

---

#### Algorithm 2 Modular Multiplication and Barrett Reduction

---

**Require:**  $a, b, m \in \mathbb{Z}_q$ ,  $s = 2\lceil \log q \rceil$ ,  $m = \lfloor 2^s/q \rfloor$ .

**Ensure:**  $z = a \cdot b \bmod q$

- 1:  $z \leftarrow a \cdot b$  ▷  $\log q \times \log q \rightarrow 2 \log q$
  - 2:  $t \leftarrow (z \cdot m) \gg s$  ▷  $2 \log q \times \log q \gg 2 \log q \rightarrow \log q$
  - 3:  $z \leftarrow z - (t \cdot q)$  ▷  $2 \log q - \log q \times \log q \rightarrow 2 \log q$
  - 4: **if**  $z \geq q$
  - 5:  $z \leftarrow z - q$
- 

**4.1.2 Enable High-precision Ops using int8 MACs.** To resolve the precision gap, CROSS proposes *chunk-wise decomposition* to represent each high-precision coefficient as many low-precision chunks, such that high-precision arithmetic is achieved by many low-precision chunk-wise operations, as shown in Alg. 3, where HP indicates high-precision.

**Chunk Decomposition:** Assuming the bit precision of hardware MAC is  $bp$ , a given data  $a$  with  $\log q$  bits will be broken down into  $K = \lceil \frac{\log q}{bp} \rceil$  chunks  $a^k$ ,  $0 \leq k < K$ , each chunk has  $bp$  bits, as shown in Alg. 3. All high-precision data will be stored and computed as chunks.

---

#### Algorithm 3 Chunk Decomposition: Map High-precision Scalar Operations as Low-precision Chunk-wise Operation

---

**Require:**  $a, b, c \in \mathbb{Z}_q$  with  $\log q$ ,  $\log q$ ,  $2 \log q$  bits, hardware bit precision  $bp$ , right shift  $s$  bits for shifted mul.

- 1:  $K \leftarrow \lceil \frac{\log q}{bp} \rceil$  ▷ Number of chunks
  - 2: **procedure** CHUNKDECOMPOSE( $a$ )  $\rightarrow [a^k]_{0 \leq k < K}$
  - 3:  $\text{bits} \leftarrow \text{binary}(a)$
  - 4:  $a^k \leftarrow \text{bits}[k \cdot bp : (k+1) \cdot bp]$ , for  $0 \leq k < K$
  - 5: **end procedure**
  - 6: **procedure** CHUNKMERGE( $[a^k]_{0 \leq k < K}$ )  $\rightarrow a$
  - 7:  $a[k \cdot bp : (k+1) \cdot bp] = a^k$ , for  $0 \leq k < K-1$
  - 8: **end procedure**
  - 9: **procedure** CARRYPROPAGATE( $[a^{k_1}]_{0 \leq k_1 < K}$ )  $\rightarrow [z^{k_2}]_{0 \leq k_2 < K+1}$  ▷  $z$  has  $bp$  bits,  $a$  has larger than  $bp$  bits
  - 10: **for** iter in  $K$ :
  - 11:  $\text{bits}^k \leftarrow \text{binary}(a^k)$ ;  $\text{numbit}^k \leftarrow \text{len}(\text{bits}^k)$
  - 12:  $a_L^k \leftarrow \text{numbit}^k[0 : \text{numbit}^k \gg -1]$ ;
  - 13:  $a_H^k \leftarrow \text{bits}^k[\text{numbit}^k \gg : \text{numbit}^k - 1]$
  - 14:  $z^0 = a_L^0$ ;  $z^K = a_H^K$ ;  $z^k = a_L^{k+1} + a_H^k$ ,  $0 < k < K$
  - 15:  $a^k = z^k$
  - 16: **end procedure**
  - 17: **procedure** HPSCALARADD( $a, b$ )  $\rightarrow z$  ▷  $z = a + b$
  - 18:  $[a^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(a)$
  - 19:  $[b^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(b)$
  - 20:  $c^k = (a^k + b^k)$ , for  $0 \leq k < K$
  - 21:  $z^k \leftarrow \text{CARRYPROPAGATION}(c^k)$ , for  $0 \leq k < K$
  - 22:  $z \leftarrow \text{CHUNKMERGE}(z^k)$ , for  $0 \leq k < K$
  - 23: **end procedure**
  - 24: **procedure** HPSCALARMULT( $a, b$ )  $\rightarrow z$  ▷  $z = a \times b$
  - 25:  $[a^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(a)$
  - 26:  $[b^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(b)$
  - 27:  $c^{k_1+k_2} += (a^{k_1} \times b^{k_2}) \cdot bp$ , for  $0 \leq k_1, k_2 < K$
  - 28:  $z^k \leftarrow \text{CARRYPROPAGATION}(c^k)$ , for  $0 \leq k < 2K$
  - 29:  $z \leftarrow \text{CHUNKMERGE}(z^k)$ , for  $0 \leq k < 2K$
  - 30: **end procedure**
  - 31: **procedure** HPSHIFTEDMULT( $a, c$ )  $\rightarrow z$  ▷  $z = a \times c \gg s$
  - 32:  $a^k, c^k \leftarrow \text{CHUNKDECOMPOSE}(a, c)$
  - 33:  $k_r = 0$  ( $k_r$  records the total number of right shifting)
  - 34: **for**  $0 \leq k_z < \lceil \frac{3 \log q}{bp} \rceil$
  - 35: **for**  $0 \leq k_1 \leq k_z$
  - 36:  $z += (a^{k_1} \times c^{k_z-k_1}) \ll (k_z - k_r) \cdot bp$
  - 37: **if**  $k_z < \lceil \frac{2 \log q}{bp} \rceil$
  - 38:  $z = z \gg bp$  ▷  $z$  is always using  $\log q$  bits
  - 39:  $k_r +=$
  - 40: **end procedure**
-

**High-precision Scalar Addition:** A  $\log q$ -bit addition boils down to (1) chunk decomposition, (2) chunk-wise addition, (3) carry propagation across chunks, and (4) bitwise concatenation to merge chunks back to the high-precision result.

**High-precision Scalar Multiplication:** Multiplying two  $\log q$ -bit coefficients  $a \times b$  to obtain a  $2 \log q$ -bit result is mapped through (1) performing  $K^2$   $bp$ -bit multiplications for  $a^i, b^j$ , ( $0 \leq i, j < K$ ), (2) shifted accumulation of chunk-wise multiplication results into final  $2 \log q$ -bit result.

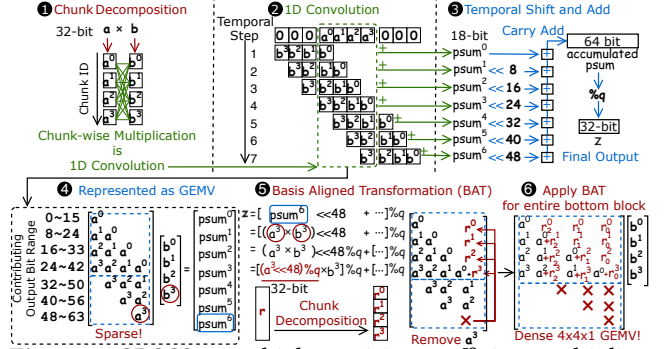
**High-precision Shifted Scalar Multiplication:** In Alg. 2, multiplying a  $\log q$ -bit number by a  $2 \log q$ -bit number produces a  $3 \log q$ -bit result, which is ultimately right-shifted by  $2 \log q$  bits to yield a  $\log q$ -bit output. Therefore, the least significant  $2 \log q$  bits serve only as temporary storage and need not be stored. To exploit this, CROSS partitions the  $2 \log q$ -bit right shift into multiple steps, each discarding lower  $bp$  bits of the final result while accumulating chunk-wise multiplication product. As a result, this reduces  $3 \log q$ -bit memory overhead of the final result to  $\log q$  bits (Alg. 3).

Operations in Alg. 3 are only mapped to the VPU of TPUv4, which supports at most 32-bit integer arithmetic, i.e.  $bp \leq 32$ . Mapping Alg. 3 to MXU is inefficient because computation patterns does not fit the datapath of matrix multiplication engine, resulting in low utilization.

**4.1.3 Schedule Chunk-wise Multiplication as Convolution.** To leverage the available matrix multiplication engine of AI accelerators for accelerating chunk-wise multiplication, such as line 27 in Alg. 3, CROSS schedules low-precision chunk-wise multiplications as 1D convolution.

Taking mapping 32-bit coefficient multiplication to  $bp = 8$ -bit compute as an example, as shown by ❶ in Fig. 6, CROSS segments each coefficient into four uint8 chunks and then maps chunk-wise multiplication as 1D convolution (❷). Specifically, CROSS directly reads uint32 from local register, views it as a vector of four uint8 chunks, and pads  $\frac{32}{bp} - 1 = 3$  zeros on both sides. Then, convolving the padded  $a$  with chunk-decomposed  $b$  over seven temporal cycles yields seven partial sums ( $psum^k, k \in [0, 6]$ ), each at most  $2bp + \log \frac{32}{bp} = 16 + 2 = 18$  bits<sup>2</sup>. These partial sums are shifted and accumulated (❸) to 64-bit final result  $psum$ , which is stored in eight uint8 registers.  $psum$  is finally modular reduced to 32 bits via Barrett Reduction (Alg. 2).

**4.1.4 Basis Align Transformation (BAT).** Although mapping chunk-wise multiplication as 1D convolution adapts its computation pattern to native datapath of the matrix multiplication engine in AI ASIC, in the chunk-wise multiplication example above, 3 padding zeros introduce 12 redundant computation, leading to an inefficiency of  $16/(12 + 16) \approx 57\%$  effective compute utilization. To intuitively illustrate such



**Figure 6.** CROSS maps high-precision coefficient multiplication into 1D convolution and temporal shifted accumulation (superscript represents chunk index). Further, Basis Align Transformation (BAT) further optimizes the 1D Convolution into a dense matrix vector multiplication (GEMV). Alternatively, BAT could convert  $b$  into matrix and  $a$  into vector.

an inefficiency, we represent such convolution-based mapping as matrix-vector multiplication as shown by ❹ in Fig. 6, where inefficiency is illustrated as zeros in the sparse left matrix. To remove such redundant computation, CROSS proposes BAT to convert the sparse matrix into a smaller dense matrix (❺), with detailed conversion introduced as follows.

In both the left matrix and its resulting vector (❹), elements in the same row contribute to the same bit range in the accumulated 64-bit partial sum  $psum$ . Specifically, for each row  $k \in [0, 6]$ , the contributed bit range is from  $k \cdot bp$  to  $(k + 2) \cdot bp + 2$ . The minimal non-zero value contributed by each row is termed the row’s *output basis*. For instance, the  $k$ -th row has an output basis of  $2^{k \cdot bp}$ .

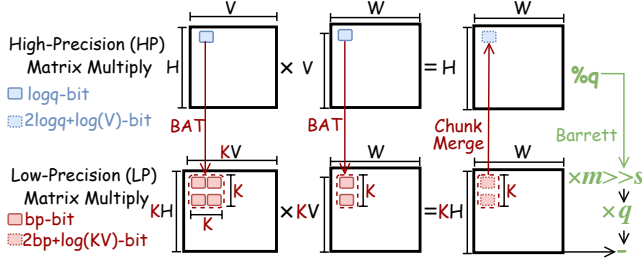
Although the input left matrix spans seven distinct bases, after modular reduction, the final result  $z$  retains only the lowest four bases, corresponding to  $k \in [0, 3]$ . All rows contributing to higher bases are intermediate results. Hence, to remove elements associated with higher bases, CROSS applies a modular reduction step directly to those elements in the bottom blue dashed box of the left matrix (❻), thereby realigning them with the four lowest bases and moving them back to the top blue dashed box (❼ in Fig. 6). This process is thus termed as *Basis Align Transformation (BAT)*.

For example,  $a^3 \times b^3 = psum^6$  (in red circle of ❹ and ❺) illustrates BAT.  $psum^6$ , with the output basis of  $2^{48}$ , is reduced to the four lowest bases in the final result. BAT applies the modular operator directly to  $a^3 \ll 48$ , yielding  $r = (a^3 \ll 48) \bmod q$ . The result,  $r$ , is 32 bits long and has a basis of 0. This allows chunk-wise decomposition to break  $r$  into four chunks ( $r^0, r^1, r^2, r^3$ ) (❻), which are then added back to the top blue dash box.

Applying BAT to all elements with bases higher than the final available bases converts the sparse input matrix into a smaller dense matrix (❼), resulting in a  $2\times$  computation speedup by halving the workload size. The transformed matrix will consume  $\frac{\log q}{bp} \times$  memory than the original data, and

<sup>2</sup>Each chunk-wise multiplication generates 16 bits. A reduction of  $\frac{32}{bp} = 4$  chunks needs at most 2 extra bits to avoid precision overflow.





**Figure 7.** Flowchart illustrating the conversion of high-precision modular matrix multiplication (HP-MatModMul) into low-precision matrix multiplication (LP-MatMul) and scalar multiplication. Precision lowering and modular reduction steps are highlighted in red and green, respectively. The total number of chunks is  $K = \lceil \frac{\log q}{bp} \rceil$ . Specifically, CROSS employs BAT to decompose each  $\log q$ -bit element from the left and right matrices into a  $K \times K$  array of  $bp$ -bit elements and a  $K$ -length vector. The data in resultant array have  $2bp + \log(KV)$  bits to accommodate potential precision overflow during reduction. Note that BAT can also convert an element of the left matrix into a vector and an element of the right matrix into an array. In summary, CROSS transforms HP MatMul into LP MatMul with increased dimensions to fully utilize the MXU.

thus BAT will be beneficial for compute-bound kernels, while Conv1D will still be invoked for memory-bound kernels.

At a higher level, BAT pays extra transformation overhead to eliminate redundant computation (⑤) and reduce the size of temporal reduction (④). Both improve computation efficiency. When value is pre-known, transformation overhead goes away because it happens offline.

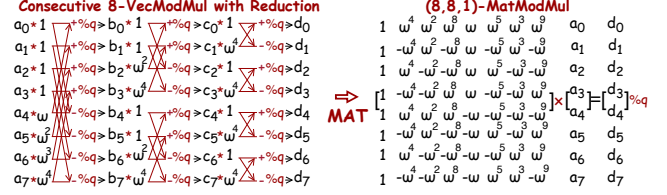
#### 4.2 Enable High-Precision Vectorized Modular Ops

Vectorized Modular Multiplication (VecModMul) with an arbitrary precision can be mapped to low-precision depth-wise 1D convolution by projecting degree into the convolution’s channel. For performance speedup, if one vector in the operation is preknown, BAT enables mapping high-precision VecModMul to dense matrix-vector multiplication.

Additionally, VecModMul with a modulus within 32 bits can leverage native 32-bit integer arithmetic directly on the VPU, further enhancing efficiency.

#### 4.3 Enable High-Precision Matrix Modular Mul.

Although ModMatMul can be accelerated by the VPU via Barrett reduction, this mapping cannot leverage the inherent data reuse in MatMul, leading to suboptimal efficiency. To address both precision and modular gaps while retaining data reuse for optimal performance, CROSS decomposes high-precision data into smaller chunks and reintegrates them into the original MatMul, forming a higher-dimensional MatMul. This approach bridges computational gaps and enhances utilization. An illustrative example is shown in Fig. 7.



**Figure 8.** MAT converts three consecutive 8-VecModMul with element-wise reductions at group of 2 per VecModMul into a single  $(8, 2^3 = 8, 1)$ -MatModMul.

In summary, this section introduces details of how CROSS supports various HE primitives including vectorized modular operators and modular matrix multiplication. This makes TPU an accelerator for HE under CROSS, because all HE kernels come as a combination of multiple primitives.

## 5 Apply CROSS to Accelerate HE on TPUv4

Enabling individual primitives facilitates HE acceleration on TPU. For better performance, this section introduces *inter-primitive optimizations* for NTT and BasisChange.

### 5.1 Case Study: Map NTT to MXU

**5.1.1 Matrix Aligned Transformation (MAT).**  $N$ -input NTT has  $\log N$  instances of  $\{\text{VecModMul}, \text{bit complement shuffling}, \text{VecModAdd}\}^3$ , as introduced in §3.1.1. To further optimize performance, we introduce the *MAT* for inter-primitive optimizations to eliminate the memory reorganizations residing in NTT and convert it to matrix multiplication that is more suitable for 2D MXU. Specifically, MAT optimizes  $\log N$  instances of consecutive VecModMul with cross-coefficient reduction of  $rg$  coefficients by converting them into a single, larger modular matrix-vector multiplication<sup>4</sup>, denoted as  $(N, \min(rg^M, N), 1)$ -MatModMul.

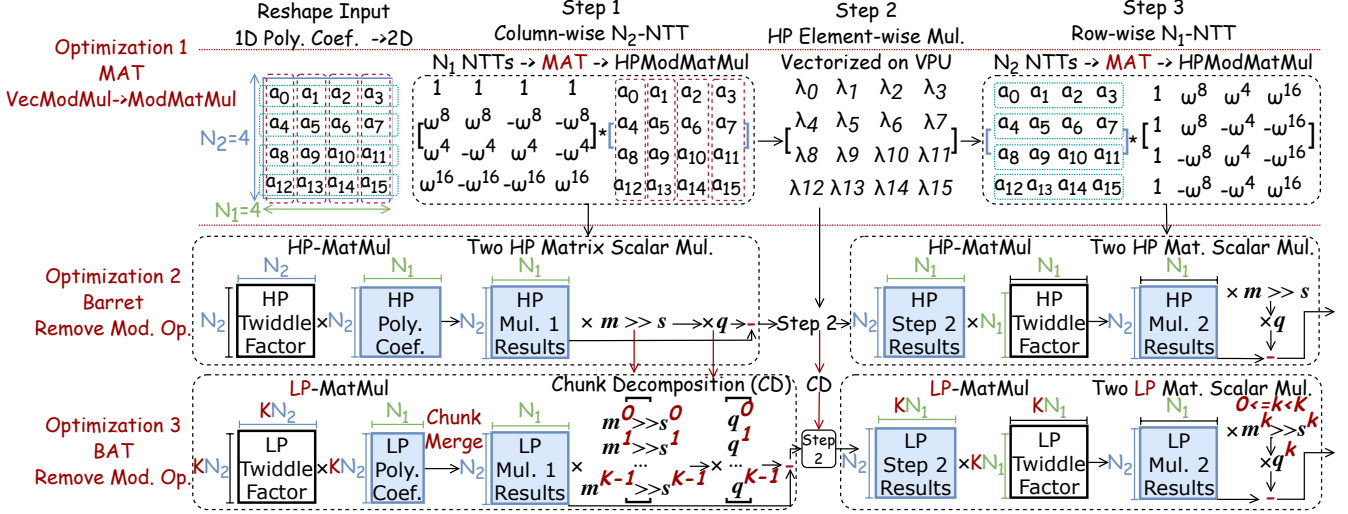
Taking 8-input NTT with three stages (Fig. 5a) as an example, each stage consists of VecModMul followed by a reduction of all elements as a group of 2 (VecModAdd or VecModSub) as shown in Fig. 8. MAT achieves following:

- *Merging Operations:* It merges the three instances of 8-VecModMul and the subsequent VecModAdd/Sub operations into a single  $(8, 2^3 = 8, 1)$ -MatMul.
- *Consolidating Modular Reductions:* MAT combines three separate 8-element modular reductions (mod  $q$ ) into one modular reduction applied to final results of MatMul. Intermediate results from middle stages are represented as an array of multiple elements to avoid precision overflow.

By restructuring computation in this manner, MAT transforms vectorized operations—which cannot efficiently utilize MXU—into a form that fully exploits the MXU’s capabilities. Specifically, merging  $\log N$  instances of consecutive VecModMul and VecModAdd/Sub operations allows us to

<sup>3</sup>Convert  $N/2$ -VecModSub as  $N/2$ -VecModAdd of negative coefficients.

<sup>4</sup>pure VecModMul without cross-coefficient reduction cannot be converted into MatModMul, which will be mapped to VPU for parallel acceleration.



**Figure 9.** Detailed CROSS flow for mapping NTT to low-precision Multiplication on TPUv4.

fully utilize an MXU with a  $N \times N$  systolic array. For example, to fully utilize a  $128 \times 128$  MXU, MAT would merge  $\log_2(128) = 7$  instances. Less stages lead to low utilization. MAT quadratically increases compute overhead such that more stages lead to inefficiency, rendering  $\log N$  stages a sweetpoint for  $N \times N$  compute array.

At a high level, MAT pays more on-chip memory storage for higher MXU utilization, reducing computation latency.

**5.1.2 Optimization 1: Applying MAT to NTTs.** Practical polynomial dimensions in HE can be larger than  $2^{16}$ , which requires NTTs with larger than 16 stages, which often not divided by the sweetpoint seven as discussed in §5.1.1. To achieve high efficiency, CROSS adopts the recursive 4-step NTT algorithm [18, 27] to decompose a large  $N$ -input NTT (where  $N = N_1 \times N_2$ ) into smaller  $N_1$ -input and  $N_2$ -input NTTs so that MAT gives better global efficiency.

4-step NTT requires explicit transpose. To eliminate it, CROSS offline transposes the twiddle-factor matrix and swapping the twiddle factors and coefficients in the online matrix multiplication, as illustrated in Fig. 9. Final steps are:

- Step 1:* Perform  $N_2$ -input NTTs on each of the  $N_1$  columns.
- Step 2:* Multiply the results by precomputed parameters.
- Step 3:* Perform  $N_1$ -input NTTs on each of the  $N_2$  rows.

**5.1.3 Optimization 2: Applying Barrett to remove Mod.** CROSS adopts Barrett to convert all modular reduction as a serial of matrix scalar shifted multiplication and matrix scalar multiplication, as shown by the *optimization 2* in Fig. 9. This converts HP-MatModMul into HP-MatMul/ScalarMul.

**5.1.4 Optimization 3: Applying BAT to lower precision.** To further lower precision demand, HP-MatMul is converted by BAT into LP-MatMul. These LP-MatMul are directly accelerated by TPUv4’s MXU with full utilization.

### 5.1.5 Walk Through Example Step 1.

**Optimization 1: Convert  $N_2$ -NTT to Matrix Multiplication.** For Step 1, an  $N_2$ -NTT is performed on each of the  $N_1$  columns. Each individual  $N_2$ -NTT is represented by an  $N_2 \times N_2 \times 1$  matrix multiplication. Since all  $N_1$  instances of the  $N_2$ -NTT share the same twiddle factors, they are combined into a single  $N_2 \times N_2 \times N_1$  HPMoMatMul in Fig. 9.

**Optimization 2: Remove % Ops in HPMoMatMul** The resulting  $N_2 \times N_2 \times N_1$  HPMoMatMul is decomposed into: (1) One  $N_2 \times N_2 \times N_1$  HP-MatMul, (2) One shifted multiplication between  $N_1 \times N_2$  matrix and scalar  $m$ , and (3) One  $N_1 \times N_2$  matrix scalar multiplication in Fig. 9.

**Optimization 3: Lower High-Precision Multiplications.** Finally, CROSS applies BAT to (1) in Optimization 2 to lower HP-MatMul to LP-MatMul. As a result, the matrix dimension expands by a factor of  $K$  in Fig. 9, similar to Fig. 7.

By combining MAT and BAT, CROSS efficiently maps the NTT to the MXU, optimizing both computational complexity and hardware utilization. Post-MAT NTT could achieve up-to 1000× performance improvement over pure vectorized NTT implementation because TPUv4 is not good at bit-complement shuffling.

## 5.2 Case Study: Mapping Basis Change to MXU

In mapping the Basis Change operation to the MXU, CROSS utilizes the VPU to directly accelerate the VecModMul in Step 1 in §3.1.2. For the  $(N, l, l')$ -MatModMul in Step 2, CROSS employs both BAT and Barrett reduction to convert it into a higher-dimensional  $(KN, Kl, l')$  matrix multiplication, similar as Fig. 7, which runs efficiently the MXU.

Note that for basis change, the matrix dimensions  $Kl'$  and  $Kl$  typically range from 272 to 403 and 204 to 286, respectively, under standard security parameters (as discussed later in Tab. 5). To achieve optimal performance, it is necessary to explore potential block sizes through brute-force search.

**Table 4.** Challenges and Solutions

	Challenge	CROSS Solution
Functional Barrier	Lack of modular reduction Precision Gap	Barrett/Montgomery Chunk Decomposition
Performance Challenge	inefficient chunk-wise ops vectorized (%×) + reduction	parallel chunk-wise Ops (BAT) Convert to Matrix (MAT)

## 6 Evaluation

This section assesses TPUv4’s efficiency with other existing platforms. While TPUv4 with CROSS outperforms CPUs, GPU (V100+100x [35]), and FPGA (Xilinx Alveo U280+FAB [3]), it lags behind dedicated HE ASICs for lack of specialized units for modular operations and HE operators. Additionally, we explore the performance improvement and overhead of integrating dedicated modular components.

### 6.1 Methodology

We select Google’s TPU as a representative ASIC AI accelerator and enable deployment on a real TPUv4 by converting HE kernels into convolution and MatMul and leveraging JAX [14] and Pallas [9] to program TPUv4. We report the latency from trace\_viewer in XLA profiler [19] and resources overhead from post-PnR open-access literature [32].

**Security Parameter Setup** The 128-bit security is commonly accepted security level and Tab. 5 lists 6 potential parameter setups with different post-RNS precision. Lower post-RNS precision always gives better performance on TPUv4. This is because processing larger bitwidth data in the MXU’s low-precision MAC leads to a quadratic increase in the total number of chunk-wise multiplication, as explained in §2.1.2. Therefore, we choose security parameter set 6 with 28-bit modular precision throughout the the evaluation.

**CROSS Configurations** For security parameter set 6, each 28-bit coefficient is stored in 32-bit unsigned integer and decomposed into  $K = \lceil \frac{\log q=28}{bp=8} \rceil = 4$  chunks if leveraging MXU. Further, CROSS configures 4-step NTT with  $2^8$ -NTT in both step 1 and step 3. Eg. step 1 is finally converted to (1)  $KN_2 \times KN_2 \times N_1 = 1024 \times 1024 \times 256$  MatMul with each element stored as unsiged 8-bit integer, (2)  $N_2 \times N_1 = 256 \times 256$  32-bit matrix scalar multiplication with each coefficient as 32 unsigned integer followed by 32-bit right shifting. (3)  $N_2 \times N_1 = 256 \times 256$  32-bit matrix scalar multiplication. All twiddle factors are compiled offline and being prefetched to TPU, consuming 1.25 MB on-chip memory.

**Baseline** Performance is highly dependent on security parameters, we adopt each platform’s published configurations when evaluating the same HE operators. Specifically, CPU: (1) OpenFHE running on an AMD 5950× with AVX-512 and multithreading (2) State-of-the-art Lattigo [48] running on an Intel i5-6600k with AVX2; GPU: (1) 100× [35] on an NVIDIA V100; (2) SoTA Cheddar [38] on an NVIDIA A100; FPGA: SotA FAB [3]. Wall-clock latencies for GPUs and FPGA are taken directly from their respective publications [3, 35]. We also compare against various SotA HE ASICs

and select CraterLake [55] as our ASIC baseline because its setup aligns with CROSS. To enable fair comparison with Google TPUv4, we proportionally scale CraterLake’s compute and memory resources to achieve comparable power. An overview of different baselines is detailed in Tab. 5.

**Workload:** We adopt ML workloads without bootstrapping including LoLa-MNIST, LeNet and Logistic Regression<sup>5</sup> [30], and four backbone HE kernels as workloads, including HEAdd, HEMult, HERescale and HERotate [17]. Such kernel-wise comparisons show its generality on various applications.

### 6.2 Comparison against SotAs

**SotAs on Available Devices:** CROSS enables TPUv4 to achieve (1) 327× and 12× speedup over OpenFHE (AMD 5950, CPU) and SoTA Lattigo (Intel i5-6600k, CPU), (2) 5× speedup over NVIDIA-V100 (100x [35]) and 0.5× slower than SotA NVIDIA-A100 (Cheddar [38]), (3) 1.05× speedup SotA FPGA (Xilinx Alveo U280 + FAB [3]), as shown in the Tab. 5. We note that NVIDIA-A100 has 2.35× more power consumption so that TPUv4 achieves 1.17× better performance per watt over NVIDIA-A100 + Cheddar [38]. Further, under one simple LeNet-style network, LoLa-MNIST, tested on the MNIST dataset [15], TPU with CROSS consumes 49 ms for a single inference, which is 60× faster than OpenFHE (AMD 5950, CPU). This is because, by effectively leveraging available compute and memory from TPUv4 via CROSS, the overall throughput is significantly larger than that of CPU.

**HE ASIC SotA:** Under Logistic Regression as the workload, compared against HE ASIC accelerators such as Sharp [39], CraterLake [55], ARK [40] and BTS [42], TPUv4 with CROSS is 33.2×/2.96×/5.87×/5.53× slower, which is derived from the HE-Mult slowdown in Tab. 5 for lack of dedicated hardware for modular operations and NTT.

### 6.3 Ablation Study

**6.3.1 Impact of Workload Sizes.** MatMul in HE workloads mainly arises from NTT and BasisChange operations. NTT-based MatMul typically involves square matrices of size  $2^7$  to  $2^{10}$ , whereas BasisChange results in skewed MatMul, with one dimension equal to degree  $N$  and the other being the number of limbs  $l$  or  $l'$ . We evaluated the performance of the proposed precision reduction techniques, BAT and convolution-based mapping (Fig. 6), with latency metrics for various sizes (Tab. 7). The latency of MAT + BAT scales roughly linearly with the increase in FLOPs, achieving approximately 85% computation utilization on average. Additionally, BAT consistently improves performance by 1.08× to 1.99× over convolution-based mapping, owing to reduced redundant zero computation and less temporal reductions.

<sup>5</sup>HELRL [29] is a binary classification model using logistic regression. We trained the model for 32 iterations, each with a batch containing 1024 14×14-pixel MNIST images, where an iteration is a gradient update step with a single batch, and report average execution time per iteration.

**Table 5.** HE kernel latency comparison with SotAs. Speedup of CROSS over other designs is in bold, unit: *us*. Speedup or slowdown of CROSS on TPU compared to SotAs are listed in parenthesis, unavailable data is noted as N/A.

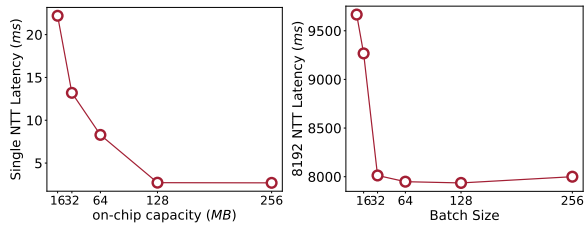
Library	OpenFHE [11]	Lattigo [48]	100x[35]	Cheddar [38]	FAB [3]	CraterLake [55]	CROSS
hardware	AMD 5950	i5-6600k	V100	A100	Alevo U280	Dedicated	TPUv4
Type	CPU	CPU	GPU	GPU	FPGA	HE ASIC	AI ASIC
Power (W)	105	91	300	400	215	280	170
Technology Node	7 nm	14 nm	7 nm	7 nm	16 nm	14/12 nm	7 nm
Date Introduced	2020	2015	2017	2020	2019	2022	2021
Parameter Setup	Set 1	Set 2	Set 3	Set 4	Set 5	Set 6	
( $\log PQ, \log Q, \log(q)^*$ )	(2596, 1947, 59)	(1728, N/A, N/A)	(3220, 2305, 52)	(1767, N/A, 52)	(2364, 1693, 52)	(1904, 1428, 28)	
Degree ( $N$ ), Limb ( $L$ )	( $2^{17}$ , 33)	( $2^{16}$ , 31)	( $2^{17}$ , 44)	( $2^{16}$ , 54)	( $2^{16}$ , 32)	( $2^{16}$ , 51)	
$D_{num}$	3		3	3	4	3	3
Security level	128	128	128	128	128	128	128
Ciphertext Size (MB)	60.84	N/A	35.75	N/A	13	11.15	
HE-Add (Latency, us)	31423 ( <b>9639</b> $\times$ )	4500 ( <b>1380</b> $\times$ )	378 ( <b>116</b> $\times$ )	80 ( <b>24</b> $\times$ )	40 ( <b>12</b> $\times$ )	8.75 ( <b>2.9</b> $\times$ )	3.26
HE-Mult (Latency, us)	533497 ( <b>327</b> $\times$ )	19400 ( <b>12</b> $\times$ )	7960 ( <b>5</b> $\times$ )	850 ( <b>0.5</b> $\downarrow$ )	1710 ( <b>1.05</b> $\times$ )	35 ( <b>0.02</b> $\downarrow$ )	1628
Rescale (Latency, us)	5784 ( <b>26.8</b> $\times$ )	65700 ( <b>304</b> $\times$ )	1200 ( <b>5.56</b> $\times$ )	N/A	190 ( <b>0.88</b> $\downarrow$ )	9 ( <b>0.04</b> $\downarrow$ )	216
Rotate (Latency, us)	442224 ( <b>392</b> $\times$ )	N/A	6600 ( <b>5.85</b> $\times$ )	N/A	1570 ( <b>1.39</b> $\times$ )	27 ( <b>0.02</b> $\downarrow$ )	1128

**Table 6.** Logistic Regression comparison with HE ASICs. Speedup of CROSS over other designs is in bold, unit: *ms*.

hardware	Sharp	BTS	ARK	CL [55]	CROSS
Type			HE ASIC		AI ASIC
Power (W)	178.8	163.2	281.3	170	170
Security level	128	128	128	128	128
Logistic Regression	2.53	28.4	14.3	15.2	<b>83.98</b>

**Table 7.** BAT vs. Convolution on  $M_{H \times V} \cdot M_{V \times W} \bmod q$

	H	V	W	MAT+Conv.	MAT+BAT	speedup
NTT range	256	256	256	49.36 $\mu s$	24.83 $\mu s$	1.99 $\times$
	512	512	512	52.03 $\mu s$	42.11 $\mu s$	1.24 $\times$
	512	1024	1024	136.76 $\mu s$	124.38 $\mu s$	1.10 $\times$
	2048	2048	2048	2 ms	1.36 ms	1.50 $\times$
	4096	4096	4096	13.76 ms	8.22 ms	1.67 $\times$
	8192	8192	8192	120.5 ms	76.54 ms	1.57 $\times$
Basis Change	16384	256	256	429.40 $\mu s$	345.90 $\mu s$	1.24 $\times$
	16384	1024	256	1,118.35 $\mu s$	806.75 $\mu s$	1.39 $\times$
	8192	256	1024	763.10 $\mu s$	707.52 $\mu s$	1.08 $\times$



(a) On-chip Memory. (b) Batch Size.

**Figure 10.** Ablation study: Impact of On-chip Memory Capacity and Batch Size on NTT Latency and Throughput.

**6.3.2 Impact of Memory Capacity.** HE workloads are memory-bound, with latency dominated by NTT operators. Higher on-chip memory reduces NTT latency because more compute could be utilized, as shown in Fig. 10a.

**6.3.3 Impact of Batch Size.** High batch sizes improve NTT throughput on TPU, as shown in Fig. 10b. Aggregating 8192 NTTs, batch sizes above 64 optimize performance due to high twiddle factor reuse. However, increasing the batch size further degrades performance due to on-chip memory contention among limbs, indicating that increasing on-chip memory will enhance throughput.

#### 6.4 Case Study: Dedicated Modular Reduction

Lack of dedicated modular multiplication hardware is the critical factor in the performance gap between HE ASICs and CROSS. Therefore, we deeply dive into the performance benefits and overheads of dedicated hardware modular add-on in VPU for general modulus value as shown in Tab. 8.

- Barrett/Montgomery: To reduce area/power, we reuse ALUs in VPU for both modular reduction.
- Hardcode: we pick a special category of modulus ( $2^N \pm 2^7 + 1$ ) as RNS moduli which only requires shifting and addition/subtraction. Therefore, we implement the hardware add-on of extra adder / subtracter and shifter.

Integrating dedicated modular reduction units into the VPU’s processing elements eliminates the need for matrix scalar (shifted) multiplication steps in Algorithm 2 and Figure 7. This optimization removes intermediate results of size  $2 \log q$  bits, freeing up approximately  $\frac{2}{3}$  of the on-chip memory for other data. Consequently, this reduces the memory-bound nature of HE workloads on AI accelerators, potentially leading to a 2 $\times$  speedup in performance.

However, augmenting VPU’s 32-bit integer MAC units with dedicated modular reduction functionality incurs an area overhead ranging from 1.49 $\times$  to 2.03 $\times$ , effectively reducing the total number of available MAC units under the same area constraints, as shown in Tab. 8. Balancing the performance gains against the area overhead, we estimate a net throughput improvement of up to  $\frac{2}{1.49} \approx 34\%$ .

**Table 8.** Performance and Post-PnR Area/Power overhead of dedicated modular reduction (TSMC 28 nm, 500 MHz)

	VPU PE	Barrett	Hardcode	Montgomery
Area ( $\mu m^2$ )	1296	2016 (1.55 $\times$ )	1932 (1.49 $\times$ )	2624.83 (2.03 $\times$ )
Latency	N/A	3	2	3

## 7 Related Work

Previous studies on hardware-accelerated HE follow two main tracks. The first track proposes custom ASIC designs with the sole purpose of accelerating HE workloads. Initial proposals were relatively small [54] but quickly grew to

chips requiring hundreds of MB in memory and hundreds of mm<sup>2</sup> in area [43, 55, 58]. While these designs achieve significant performance gains over CPU baselines, they would cost millions of dollars to fabricate and deploy.

This motivates the second track of prior works, which use existing hardware to accelerate HE workloads. Following the path of AI acceleration, these works focus on GPU acceleration [23, 24, 35, 38, 41, 45, 58, 59, 65] as well as employing FPGAs as more configurable commodity hardware [3, 53, 61]. Our work falls into this second category, proposing a novel compilation techniques to better utilize *existing* hardware to accelerate HE workloads at no additional hardware cost. With the first trail [36] directly maps polynomial multiplication as matrix multiplication, this work continues the path of adapting AI accelerators for HE workloads as a promising platform for HE. This work shows that TPUv4 can be competitive with GPUs and FPGAs, enabling the same chip to support both privacy-preserving AI and raw AI. Further studies are required to support bootstrapping.

## 8 Conclusion

This work demonstrates the potential of AI accelerators (such as Google TPUv4) to accelerate Homomorphic Encryption workloads, offering competitive performance compared to CPU, SotA GPU, and SotA FPGA alternatives. We introduced CROSS, a compilation framework that enhances HE processing on TPU. CROSS is the first work enabling both AI and HE serving at the price of fabricating only one chip.

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## A Dedicated Optimization for Modulus within 32 bits

Within the security parameter, the choice of modulus bitwidth ( $\log(q)$ ) is decoupled from  $Q$  and degree. Precision considerations guide the selection as follows.

Thousands-bit coefficients are handled through two levels of precision breakdown:

- RNS Decomposition: This breaks  $\log(Q)$  into  $L$  limbs, with each limb having a coefficient of  $\log(q)$  bits.
- Chunk Decomposition: If  $\log(q)$  exceeds the native hardware precision, it is further divided into smaller chunks.

**Overhead Analysis:** RNS-based decomposition introduces a linear overhead, whereas chunk decomposition incurs a quadratic overhead. Therefore, minimizing  $\log(q)$  through RNS decomposition is preferred. For example, using the security parameter set 6 (introduced in Tab. 5) demonstrates the benefits of this approach.

The open-sourced offline compilation code for BAT could be found at [https://github.com/google/jaxite/blob/60cb6a7fae7896443be8036eb8fa6106b25c5e6e/jaxite/jaxite\\_lib/matrix\\_utils.py#L570](https://github.com/google/jaxite/blob/60cb6a7fae7896443be8036eb8fa6106b25c5e6e/jaxite/jaxite_lib/matrix_utils.py#L570), while the runtime code of it is [https://github.com/google/jaxite/blob/60cb6a7fae7896443be8036eb8fa6106b25c5e6e/jaxite/jaxite\\_lib/matrix\\_utils.py#L616](https://github.com/google/jaxite/blob/60cb6a7fae7896443be8036eb8fa6106b25c5e6e/jaxite/jaxite_lib/matrix_utils.py#L616).

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**Algorithm 4** CROSS Dedicated Mapping for 28-bit Modulus

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**Require:** modulus  $q$  of  $\log q$  bits,  $a, b, c \in \mathbb{Z}_q$  with  $\log q$ ,  
 $\log q$ ,  $2 \log q$  bits, hardware bit precision  $bp$

```
1:  $K \leftarrow \lceil \frac{\log q}{bp} \rceil$            ▶ Number of chunks (4 in our
   configuration)

2: procedure HPSCALARMULT-CONV( $a, b$ )  $\rightarrow z$  ▶  $z = a \times b$ 
3:    $[a^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(a)$ 
4:    $[b^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(b)$ 
5:    $[c^i]_{0 \leq i < 2K-1} = \text{1DCONV}([a^k]_{0 \leq k < K}, [b^k]_{0 \leq k < K})$ 
6:    $z += c^i \ll (bp * i)$  for  $0 \leq i < 2K - 1$ 
7: end procedure

8: procedure BAT( $b$ )  $\rightarrow \hat{b}_i^j$            ▶ offline compilation
9:    $[b^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(b)$ 
10:  ▶ 1D-IM2COL converts  $[b^k]$  into a matrix
11:   $[h_{ij}]_{\substack{0 \leq i < K \\ 0 \leq j < 2K-1}} \leftarrow \text{IM2COL}([b^k], \text{kernel\_size}=(K, ))$ 
12:   $\hat{b}_i^j \leftarrow h_{ij}$  for  $0 \leq i, j < K$ 
13:  for  $0 \leq i < K$  do
14:     $c_i \leftarrow 0$ 
15:    for  $K \leq j < 2K - 1$  do
16:       $c_i += h_{ij} * 2^{bp(i+j-K)}$ 
17:    end for
18:    do           ▶ redistribute chunks of higher bases
19:       $c_i *= 2^{bp*K}$ 
20:       $[c^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(c_i \bmod q)$ 
21:       $[\hat{b}_i^k]_{0 \leq k < K} += [c^k]_{0 \leq k < K}$ 
22:       $[\hat{b}_i^k]_{0 \leq k < K}, c_i \leftarrow \text{CARRYPROP}([\hat{b}_i^k]_{0 \leq k < K})$ 
23:    while  $c_i \neq 0$ 
24:  end for
25: end procedure

26: procedure HPSCALARMULT-BAT( $a, b$ )  $\rightarrow z$  ▶  $z = a \times b$ 
27:   $[a^k]_{0 \leq k < K} \leftarrow \text{CHUNKDECOMPOSE}(a)$ 
28:   $[\hat{b}_i^j]_{0 \leq i, j < K} \leftarrow \text{BAT}(b)$ 
29:   $[c^j]_{0 \leq j < K} = [\hat{b}_i^j]_{0 \leq i, j < K} \times [a^j]_{0 \leq j < K}$ 
30:   $z += c^j \ll (bp * j), 0 \leq j < K$ 
31: end procedure
```

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